

SMT0AK2 Series

Surface Mount – SMT0-263-2 kA



Additional Information



Resources



Accessories



Samples

Agency Approvals

Agency	Agency file number
	E230531

Maximum Ratings and Thermal Characteristics

($T_A = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Value	Unit
Current Rating ¹	I_{PP}	2	kA
Steady State Power Dissipation on Infinite Heat Sink at $T_J = 75^\circ\text{C}$	P_D	15	W
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^\circ\text{C}$
Typical Thermal Resistance Junction to case	$R_{\theta JC}$	1.8	$^\circ\text{C/W}$

Note:

1. Rated I_{PP} measured with 8/20 μs pulse.

Description

The SMT0AK2 TVS Diode Series is housed in a modified SMT0-263 package, achieving a compact mechanical design and compatible with automated PCB assembly. The SMT0AK2 series is designed to protect sensitive electronics against surge events and inductive load switching voltage transient events.

Features & Benefits

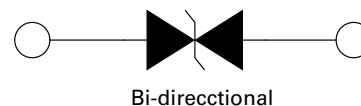
- SMT0-263 package, footprint compatible with industry popular DO-218AB package
- $V_{BR} @ T_J = V_{BR} @ 25^\circ\text{C} \times (1 + \alpha T \times (T_J - 25))$ (αT : Temperature Coefficient, typical value is 0.1%)
- Glass passivated chip junction in modified TO-263 package
- ESD protection of data lines in accordance with IEC 61000-4-2, 30 kV(Air), 30 kV (Contact)
- Fast response time: typically less than 1.0 ps from 0 Volts to $V_{BR \min}$
- Excellent clamping capability
- Low dynamic resistance enabling a low clamping voltage
- UL Recognized compound meeting flammability rating UL94 V-0
- Ideal for automated PCB assembly process, reducing manufacturing costs and improving soldering quality, as compared to axial leaded packages
- Matte tin lead-free plated
- Halogen free and RoHS compliant
- Pb-free E3 means 2nd level interconnect is Pb-free and the terminal finish material is tin (Sn) (IPC/JEDEC J-STD-609A.01)

Applications

Designed to protect sensitive electronics from:

- Over voltage surge transients
- Inductive load switching voltage transients
- PoE ports
- Small cell
- Remote Radio Units (RRUs) and Baseband Units (BBUs)
- High power DC bus in harsh environments

Functional Diagram



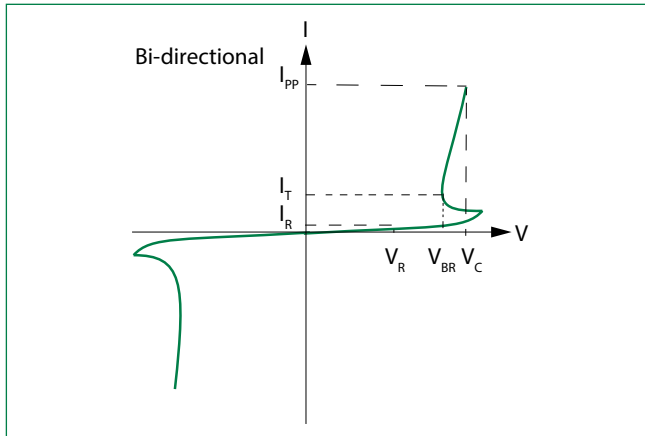
Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Part Number	Part Marking	Stand off Voltage V_{SO}	Breakdown Voltage V_{BR} (Volts) @ I_T		Test Current I_T	Maximum Peak Pulse Current I_{PP} (10/350 μs)	Maximum Clamping Voltage V_C @ I_{PP} (8/20 μs)	Maximum Peak Pulse Current I_{PP} (8/20 μs)	Maximum Reverse Leakage I_R @ V_R	Maximum Temperature coefficient of V_{BR}
		(V)	Min	Max	(mA)	(A)	(V)	(A)	(μA)	(%/C)
SMT0AK2-070C	SM2K70C	70	78.20	86.02	5	250	130	2000	2	0.074

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I-V Curve Characteristics



V_{SO} Stand-off Voltage – Maximum voltage that can be applied to the TVS without operation

V_{BR} Breakdown Voltage – Maximum voltage that flows through the TVS at a specified test current (I_T)

V_C Clamping Voltage – Peak voltage measured across the TVS at a specified I_{PPM} (peak impulse current)

I_R Reverse Leakage Current – Current measured at V_R

Ratings and Characteristic Curves ($T_A = 25^\circ\text{C}$ unless otherwise noted)

Figure 1 - Peak Pulse Power Rating Curve

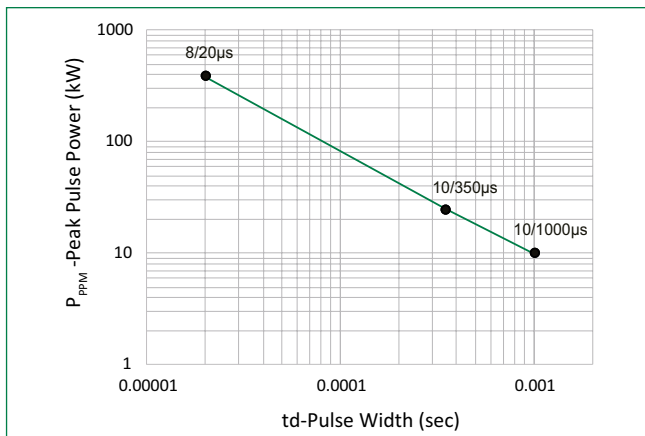
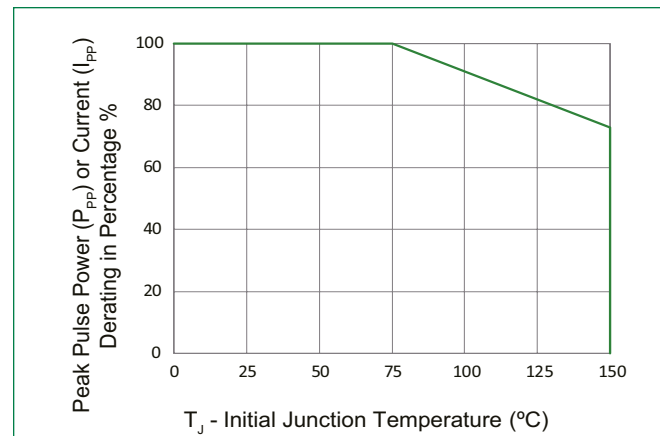


Figure 2 - Peak Pulse Power Derating Curve

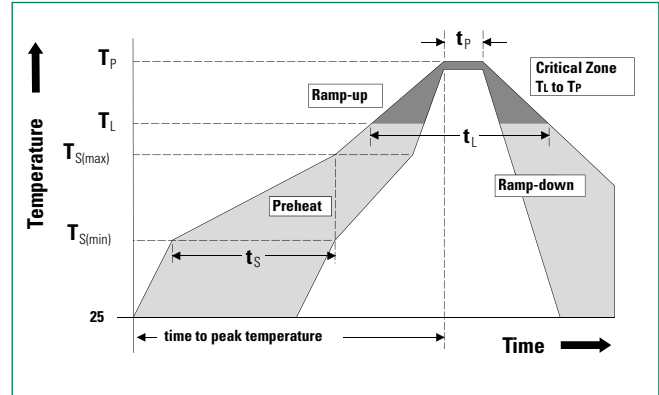


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Soldering Parameters

Reflow Condition		Pb – Free assembly
Pre Heat	- Temperature Min ($T_{s(min)}$)	150 °C
	- Temperature Max ($T_{s(max)}$)	200 °C
	- Time (min to max) (t_s)	60 - 120 secs
Average ramp up rate (Liquidus Temp (T_L) to peak		5 °C/second max
$T_{s(max)}$ to T_A - Ramp-up Rate		5 °C/second max
Reflow	- Temperature (T_L) (Liquidus)	217 °C
	- Time (min to max) (T_s)	60 – 150 seconds
Peak Temperature (T_p)		245 ^{+0/-5} °C
Time within 5 °C of actual peak Temperature (t_p)		30 seconds
Ramp-down Rate		5 °C/second max
Time 25 °C to peak Temperature (T_p)		8 minutes Max.
Do not exceed		245 °C



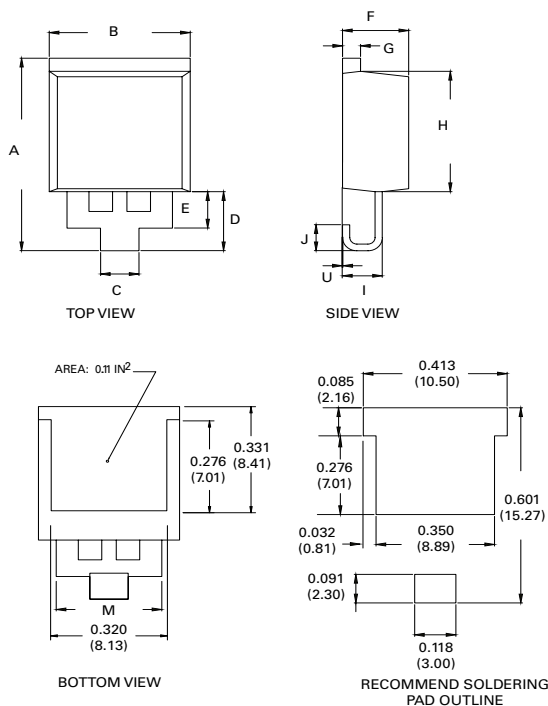
Physical Specifications

Terminal Finish	100% Matte Tin-plated
Body Material	UL Recognized compound meeting flammability classification 9UL94 V-0
Lead Material	Copper Alloy

Environmental Specifications

High Temp. Storage	JESD22-A103
HTRB	JESD22-A108
Temperature Cycling	JESD22-A104
MSL	JEDEC-J-STD-020, LEVEL 1
H3TRB	JESD22-A101
RSH	JESD22-A111

Dimensions

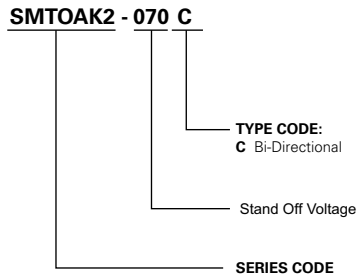


Dimensions	Inches		Millimeters	
	Min	Max	Min	Max
A	0.568	0.600	14.44	15.24
B	0.380	0.420	9.65	10.67
C	0.098	0.114	2.50	2.90
D	0.169	0.189	4.30	4.80
E	0.102	0.118	2.60	3.00
F	0.178	0.188	4.52	4.78
G	0.045	0.060	1.14	1.52
H	0.360	0.370	9.14	9.40
I	0.106	0.122	2.69	3.09
J	0.069	0.089	1.75	2.25
M	0.284	0.300	7.22	7.62
U	0	0.010	0	0.25

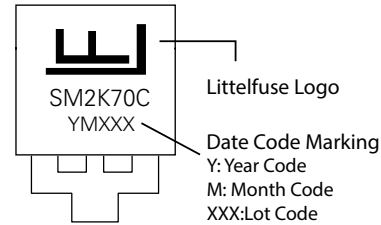
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Part Numbering System



Part Marking System

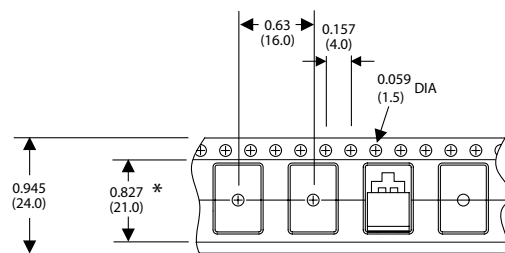


Packing Option

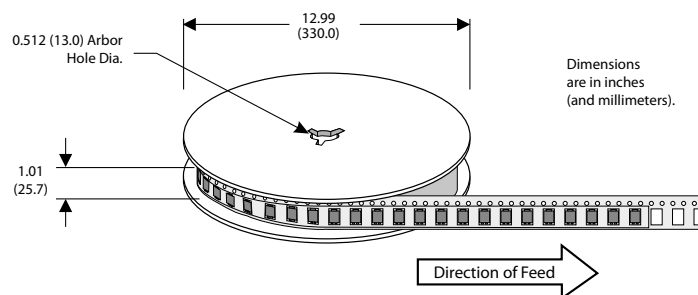
Part Number	Component Package	Quantity	Packaging Option
SMT0AK2-070C	SMT0-263	500	Tape & Reel - 24mm tape/13" reel

SMT0-263 Embossed Carrier Reel Pack (RP) Specifications

Meets all EIA-481-2 Standards



* Cover tape



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